MBRS1100T3G, SBRS81100T3G, MBRS190T3G, SBRS8190T3G, SBRS81100N, **SBRS8190N**

MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MBRS190T3 MBRS1100T3	V _{RRM} V _{RWM} V _R	90 100	V	
Average Rectified Forward Current T _L = 163°C T _L = 148°C	IF(AV)	1.0 2.0	A	
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	50	A	
Operating Junction Temperature (Note 1)	TJ	-65 to +175	°C	
Voltage Rate of Change	dv/dt	10	V/ns	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The heat generated must be less than the thermal conductivity from Junction-to-Ambient: $dP_D/dT_J < 1/R_{\theta JA}$.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance – Junction-to-Lead (T _L = 25°C)	$R_{\theta JL}$	22	°C/W

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 2) ($i_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C}$)	V _F	0.75	V
Maximum Instantaneous Reverse Current (Note 2) (Rated dc Voltage, TJ = 25° C) (Rated dc Voltage, T _J = 100° C)	Ι _R	0.5 5.0	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse Test: Pulse Width = $300 \ \mu$ s, Duty Cycle $\leq 2.0\%$.

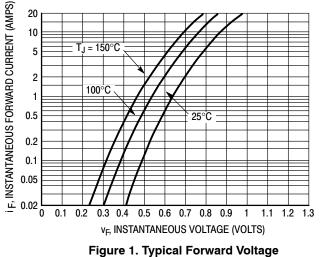
ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
MBRS1100T3G	B1C	SMB (Pb–Free)	2500 / Tape & Reel
SBRS81100T3G*	B1C	SMB (Pb–Free)	2500 / Tape & Reel
SBRS81100T3G-VF01*	B1C	SMB (Pb–Free)	2500 / Tape & Reel
MBRS190T3G	B19	SMB (Pb–Free)	2500 / Tape & Reel
SBRS8190T3G*	B19	SMB (Pb–Free)	2500 / Tape & Reel
SBRS1100T3G	B19	SMB (Pb–Free)	2500 / Tape & Reel
SBRS81100NT3G*	B1C	SMB (Pb–Free)	2500 / Tape & Reel
SBRS8190NT3G*	B19	SMB (Pb–Free)	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*SBRS8 Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements

MBRS1100T3G, SBRS81100T3G, MBRS190T3G, SBRS8190T3G, SBRS81100N, SBRS8190N



TYPICAL ELECTRICAL CHARACTERISTICS

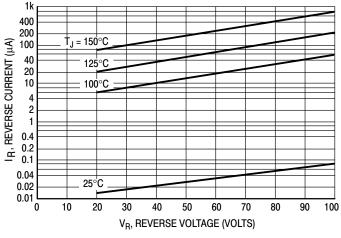
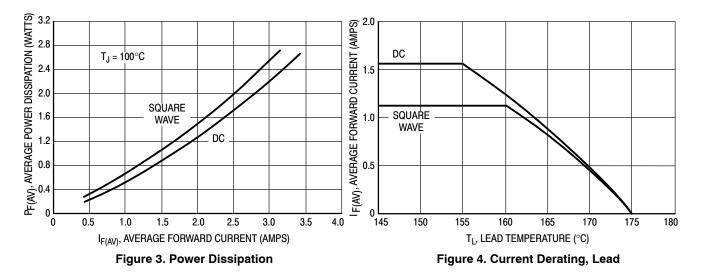


Figure 2. Typical Reverse Current*

*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these curves if V_R is sufficient below rated V_R.



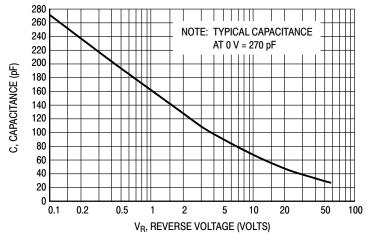
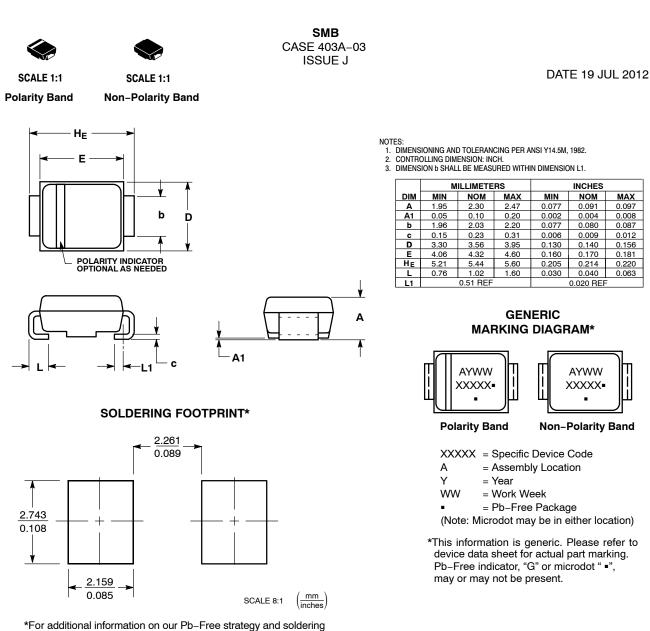


Figure 5. Typical Capacitance

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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